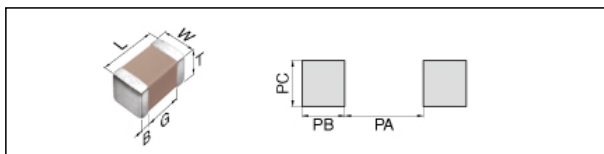


C2012X5R1E106K125AB (TDK item description : C2012X5R1E106KT****)

Applications  Commercial Grade

Feature  General (Up to 50V)

Series C2012 [EIA CC0805]



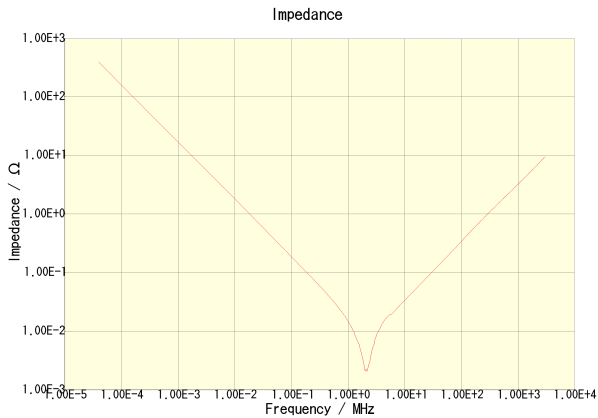
Size	
Length(L)	2.00mm +/-0.20mm
Width(W)	1.25mm +/-0.20mm
Thickness(T)	1.25mm +/-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern(PA)	1.00 to 1.30mm (Flow Soldering) 0.90 to 1.20mm (Reflow Soldering)
Recommended Land Pattern(PB)	1.00 to 1.20mm (Flow Soldering) 0.70 to 0.90mm (Reflow Soldering)
Recommended Land Pattern(PC)	0.80 to 1.10mm (Flow Soldering) 0.90 to 1.20mm (Reflow Soldering)
Recommended Slit Pattern(SD)	

Electrical Characteristics	
Capacitance	10uF +/-10%
Rated Voltage	25Vdc
Temperature Characteristic	X5R(+/-15%)
Dissipation Factor	10% Max.
Insulation Resistance	50MΩ Min.

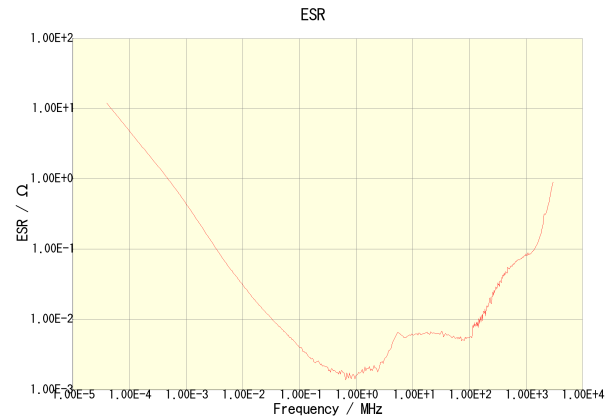
Other	
Soldering Method	Reflow, Flow
AEC Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000Pcs Min.

C2012X5R1E106K125AB

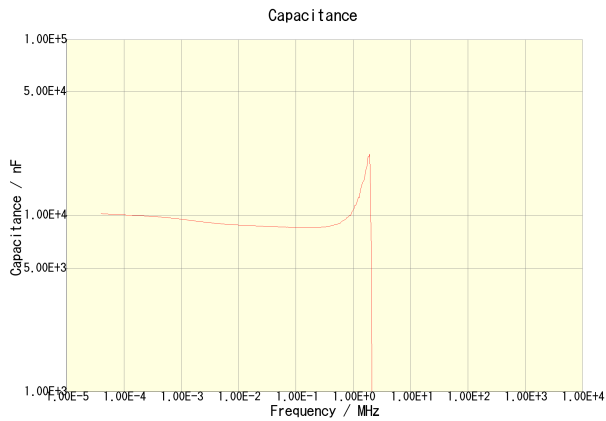
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



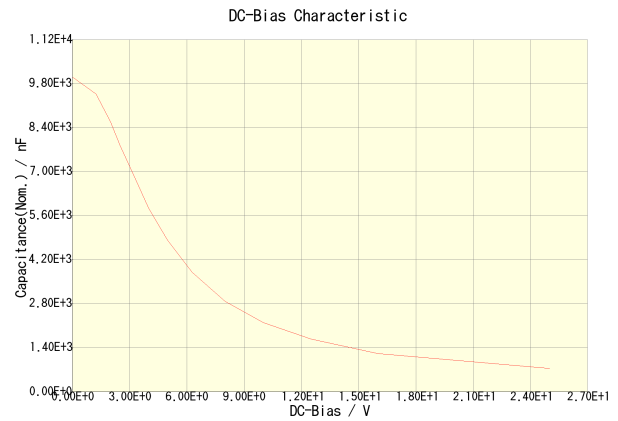
C2012X5R1E106K125AB



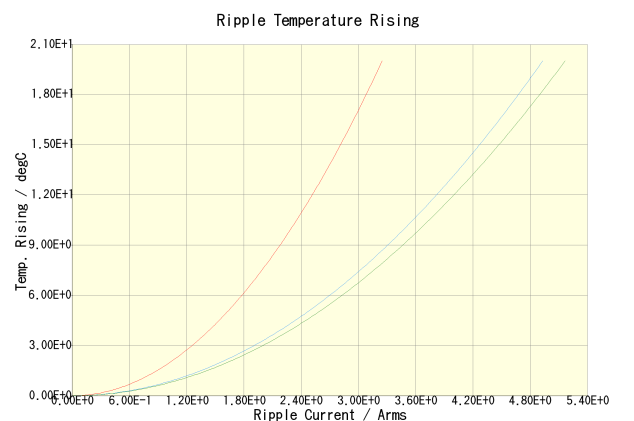
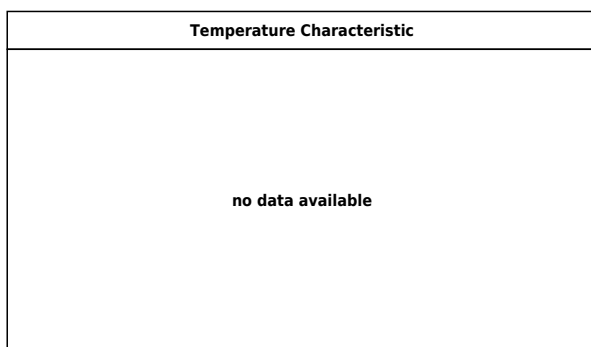
C2012X5R1E106K125AB



C2012X5R1E106K125AB



C2012X5R1E106K125AB



C2012X5R1E106K125AB(100kHz)

C2012X5R1E106K125AB(500kHz)

C2012X5R1E106K125AB(1MHz)